



Power MOSFETS

DATASHEET

LM1A092NHI8A

N-Channel
Enhancement Mode MOSFET

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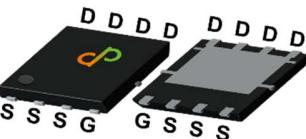
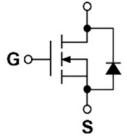
Quality Management Systems
ISO 9001:2015 Certificate

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N-Channel Enhancement Mode MOSFET

Pin Description

Product Summary

PDFN3.3*3.3		Symbol	Symbol	N-Channel	Unit
Top View	Bottom View				
					
V _{DSS}	100	V			
R _{DS(ON)-Max}	10	mΩ			
I _D	43	A			

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS Tested and Rg Tested

Applications

- Motor drivers
- DC-DC Converter

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM1A092NHI8A	PDFN3.3*3.3	Tape & Reel	5000 / Tape & Reel	1A092 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V _{DSS}	Drain-Source Voltage	100	V
V _{GSS}	Gate-Source Voltage	±20	
T _J	Maximum Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
I _S	Diode Continuous Forward Current	T _C =25°C 33	A
I _{DM} ⁽¹⁾	Pulse Drain Current Tested	T _C =25°C 128	A
I _D	Continuous Drain Current	T _C =25°C 43 T _C =100°C 27	A
P _D	Maximum Power Dissipation	T _C =25°C 36 T _C =100°C 14	W
I _D	Continuous Drain Current	T _A =25°C 9 T _A =100°C 7.5	A
P _D	Maximum Power Dissipation	T _A =25°C 1.7 T _A =100°C 1.1	W
I _{AS} ⁽²⁾	Avalanche Current, Single pulse	L=0.1mH 20 L=0.5mH 15	A
E _{AS} ⁽²⁾	Avalanche Energy, Single pulse	L=0.1mH 20 L=0.5mH 56	mJ

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJC}	Thermal Resistance-Junction to Case	Steady State 3.5	°C/W
R _{θJA} ⁽³⁾	Thermal Resistance-Junction to Ambient	Steady State 75	°C/W

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	2	3	4	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	8.5	10	$\text{m}\Omega$
		$V_{\text{GS}}=6\text{V}$, $I_{\text{DS}}=20\text{A}$	-	12	15.5	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	20	-	S
Dynamic Characteristics [®]						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	0.9	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=50\text{V}$, Freq.=1MHz	-	1560	-	pF
C_{oss}	Output Capacitance		-	525	-	
C_{rss}	Reverse Transfer Capacitance		-	55	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=30\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=6\Omega$	-	10.4	-	nS
t_{r}	Turn-on Rise Time		-	17.5	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	26.5	-	
t_{f}	Turn-off Fall Time		-	68.9	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=6\text{V}$, $V_{\text{DS}}=50\text{V}$ $I_{\text{D}}=20\text{A}$	-	20	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=50\text{V}$, $I_{\text{D}}=20\text{A}$	-	30.1	-	
Q_{gs}	Gate-Source Charge		-	8.8	-	
Q_{gd}	Gate-Drain Charge		-	8.8	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.8	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=10\text{A}$, $V_{\text{R}}=50\text{V}$	-	51	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	40	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

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N-Channel Typical Characteristics

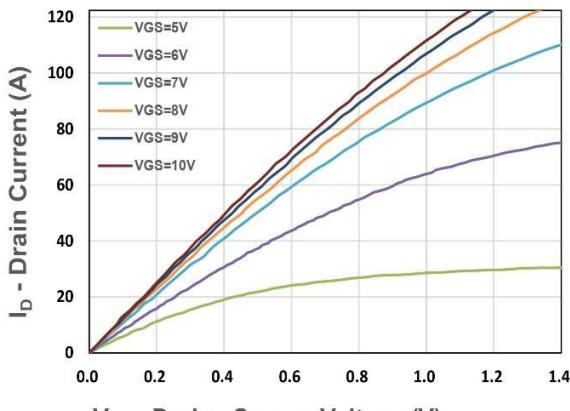


Figure 1. Output Characteristics

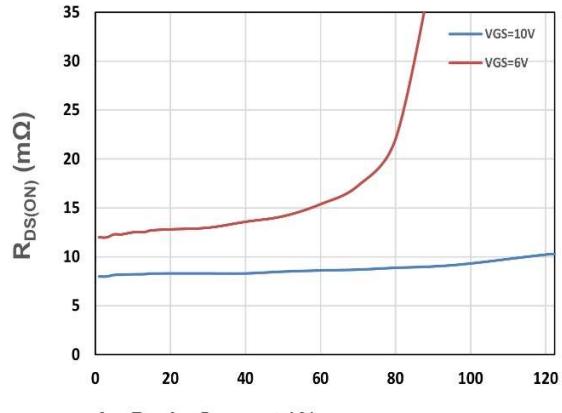


Figure 2. On-Resistance vs. ID

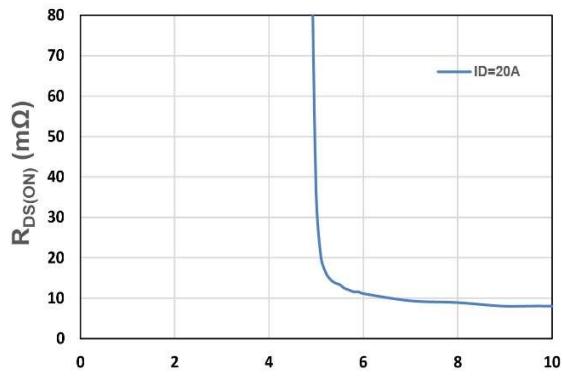


Figure 3. On-Resistance vs. VGS

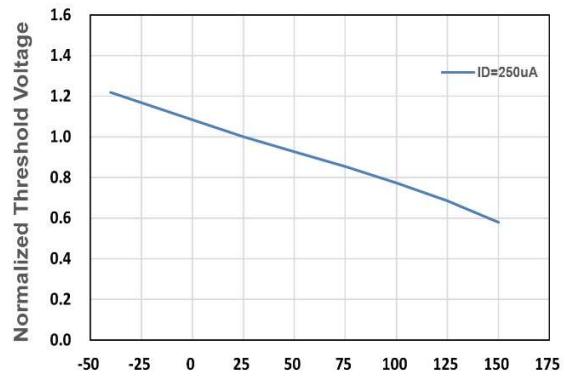


Figure 4. Gate Threshold Voltage

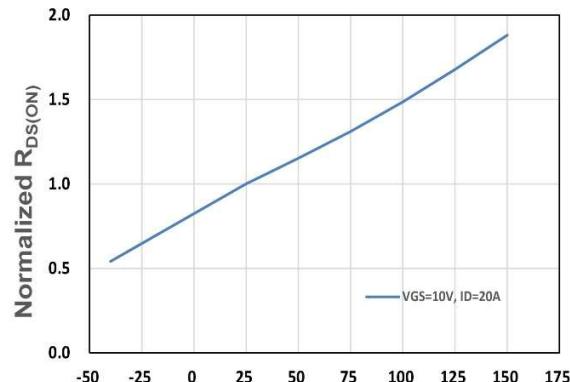


Figure 5. Drain-Source On Resistance

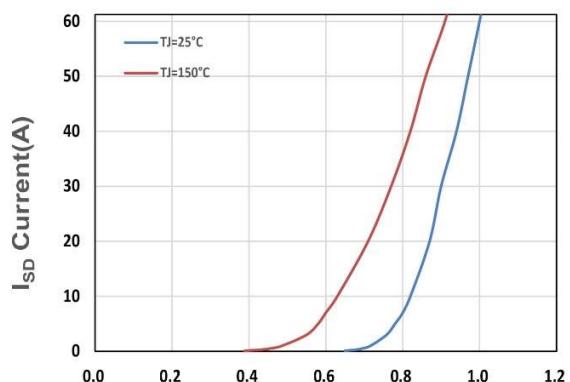
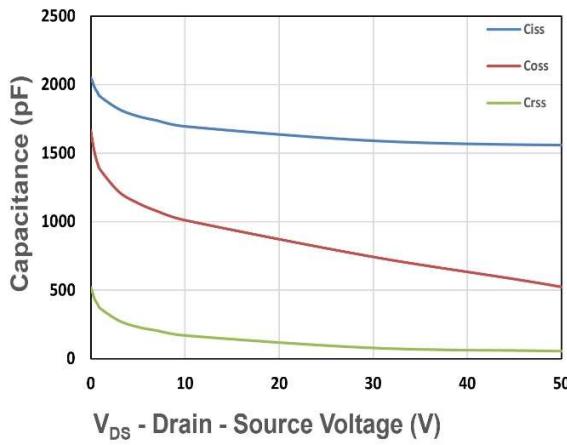


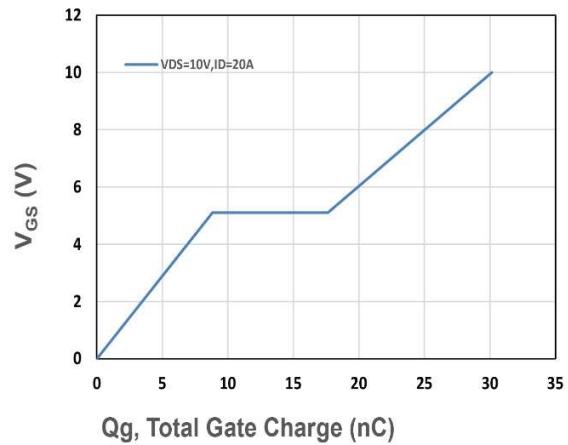
Figure 6. Source-Drain Diode Forward

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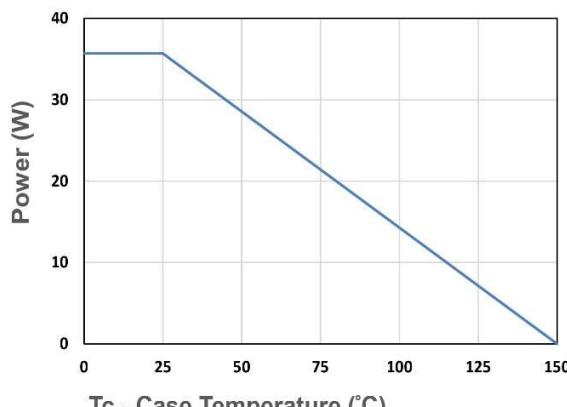
V_{DS} - Drain - Source Voltage (V)

Figure 7. Capacitance



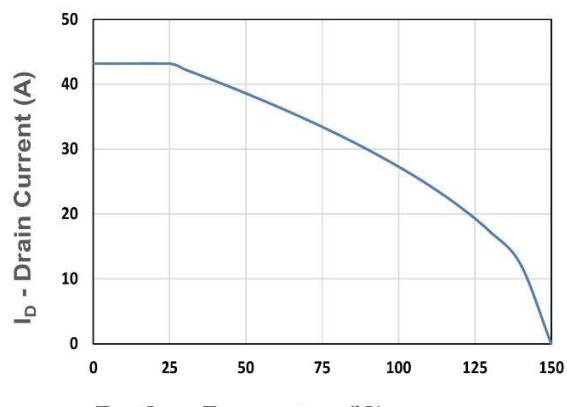
Q_g , Total Gate Charge (nC)

Figure 8. Gate Charge Characteristics



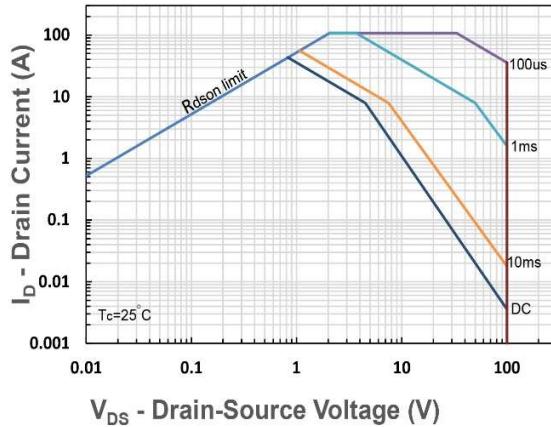
T_c - Case Temperature (°C)

Figure 9. Power Dissipation



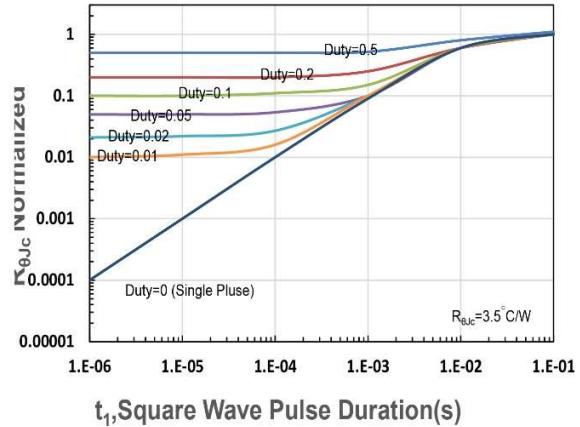
T_c - Case Temperature (°C)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



t_1 , Square Wave Pulse Duration(s)

Figure 12. $\kappa_{θjc}$ Transient Thermal Impedance